Tyrone Camarero Specifications



Camarero-SDI200C3HE-26

Key Feature

5G Core and Edge, Telecom Micro Data Center, Al Inference and Machine Learning, Network Function Virtualization, Cloud Computing

- Dual Socket E (LGA-4677) 4th Gen Intel® Xeon® Scalable processors
- 32 DIMM Slots; Up to 8TB: 32x 256GB DRAM
- Configurable PCle slot options up to 8 PCle 5.0 x8 (6 FHFL+ 2 FHHL) or 4 PCle 5.0 x16 (3 FHFL + 1 FHHL)
- Flexible networking options with 2 AIOM networking slots (OCP NIC 3.0 compatible)
- Up to 6x 2.5" hot-swap drive bays with options to support NVMe/SATA drives
- 6 heavy duty hot-swap fans with optimal fan speed control
- Redundant 2000W AC power supplies





Processor/Cache

Processor Dual Socket E (LGA-4677), 4th Gen Intel® Xeon®

Scalable processors, Intel Xeon CPU Max Series with high bandwidth memory (HBM), Up to

60C/120T; Up to 112.5MB Cache

Note: Supports up to 350W TDP CPUs (Air

Cooled)

Chipset

Chipset Intel® C741 Chipset

System Memory

Memory Capacity 32 DIMM slots, Up to 8TB: 32x 256 GB DRAM,

Memory Type: 4800MHz ECC DDR5

RDIMM/LRDIMM

Expansion Slots

PCI-Express

6 PCle 5.0 x16 FHFL slot(s), 2 PCle 5.0 x16 FHHL

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Note: If Slot 1 is configured as PCle x16, Slot 2 will be disabled; If Slot 3 is configured as PCle x16, Slot 4 will be disabled; If Slot 5 is configured as PCle x16, Slot 6 will be disabled; (Optional) If Slot 7 is configured as PCle x16, Slot 8 will be disabled.

Integrated On-Board

SATA

SATA3 (6Gbps); RAID 0/1/5/10 support

Network

2x 25GbE SFP28 with Broadcom® BCM57414 (optional), 2x 100GbE QSFP28 with Broadcom® BCM57508 (optional), 2x 100GbE QSFP28 with Intel® E810-CAM2 (optional), 2x 100GbE QSFP28 with Mellanox® CX-6 DX (optional), 4x 10GbE SFP+ with Intel® X710-BM2 (optional), 4x 10GbE BaseT with Intel® X550 (optional)

Add-on Options

Raid card Optional

Optical Drive None

Front Panel

LED Indicators LAN1 activity, LAN2 activity, System

information

Buttons

Power On/Off

Drive bays

Drive bays

6x 2.5" hot-swap NVMe/SATA drive bays (6x 2.5" NVMe hybrid), 2 M.2 NVMe OR 2 M.2 SATA3 M-Key,

2280/22110

Power Supply

Power Supply

Redundant 2000W AC power supplies

Cooling System

Fans

6 Counter-rotating, Hot-swappable 6cm

Fan(

Liquid Cooling Direct to Chip (D2C) Cold Plate (optional)

Form Factor

Form Factor

2U Rackamount

Dimensions

Dimensions

(W x H x L) - 73.5 x 40 x 203 mm

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www.tyronesystems.com

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